

#### **FEATURES**

Single-supply operation: 4.5 V to 16 V Input capability beyond the rails Rail-to-rail output swing Continuous output current: 35 mA Peak output current: 250 mA Offset voltage: 10 mV Slew rate: 6 V/µs Unity gain stable with large capacitive loads Supply current: 700 µA per amplifier

#### **APPLICATIONS**

LCD reference drivers Portable electronics Communications equipment Automotive infotainment systems

#### **GENERAL DESCRIPTION**

The AD8565/AD8566/AD8567 are low cost, single-supply, railto-rail input and output operational amplifiers optimized for LCD monitor applications. They are built on an advanced high voltage CBCMOS process. The AD8565 contains a single amplifier, the AD8566 has two amplifiers, and the AD8567 has four amplifiers.

These LCD op amps have high slew rates, 35 mA continuous output drive, 250 mA peak output drive, and a high capacitive load drive capability. They have a wide supply range and offset voltages below 10 mV. The AD8565/AD8566/AD8567 are ideal for LCD grayscale reference buffer and  $V_{\rm COM}$  applications.

The AD8565/AD8566/AD8567 are specified over the  $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range. The AD8565 single is available in a 5-lead SC70 package. The AD8566 dual is available in an 8-lead MSOP package. The AD8567 quad is available in a 14-lead TSSOP package and a 16-lead LFCSP package.

The AD8566WARMZ is the automotive grade version.

# 16 V Rail-to-Rail Operational Amplifiers AD8565/AD8566/AD8567

### **PIN CONFIGURATIONS**

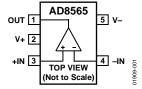


Figure 1. 5-Lead SC70 Pin Configuration

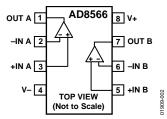


Figure 2. 8-Lead MSOP Pin Configuration

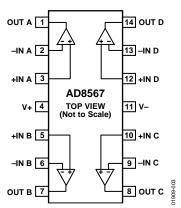


Figure 3. 14-Lead TSSOP Pin Configuration

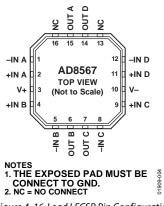


Figure 4. 16-Lead LFCSP Pin Configuration

#### Rev. F

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 One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

 Tel: 781.329.4700
 www.analog.com

 Fax: 781.461.3113
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### **TABLE OF CONTENTS**

Features 1	
Applications 1	
General Description 1	
Pin Configurations 1	
Revision History 2	,
Specifications	i
Electrical Characteristics	ì
Absolute Maximum Ratings 4	:
Thermal Resistance 4	:
ESD Caution 4	:
Typical Performance Characteristics 5	

### **REVISION HISTORY**

#### 1/10—Rev. E to Rev. F

Changes to Applications and General Description Sections	1
Changes to Figure 4	1
Added Exposed Pad Notation to Outline Dimensions	12
Changes to Ordering Guide	13

#### 8/07—Rev. D to Rev. E

Changes to Features Section	1
Changes to Phase Margin	
Changes to Table 2	4
Changes to Figure 30	10
Updated Outline Dimensions	
Changes to Ordering Guide	13
2/06—Rev. C to Rev. D	
Updated Format	Universal
Changes to Figure 6 and Figure 8	5
Added the Thermal Pad—AD8567 Section	10
Changes to Ordering Guide	13
3/04—Rev. B to Rev. C	
Changes to Specifications	2
Changes to TPC 4	4
Changes to TPC 10	5
Changes to TPC 14	6
Changes to TPC 20	7
12/03—Rev. A to Rev. B	
Updated Ordering Guide	
Updated Outline Dimensions	
10/01—Rev. 0 to Rev. A	
Edit to 16-Lead CSP and 5-Lead SC70 Pin Configuration	on 1
Edit to Ordering Guide	

#### 7/01—Revision 0: Initial Version

Theory of Operation9
Input Overvoltage Protection9
Output Phase Reversal10
Power Dissipation10
Thermal Pad—AD856710
Total Harmonic Distortion + Noise (THD + N)11
Short-Circuit Output Conditions11
LCD Panel Applications11
Outline Dimensions
Ordering Guide

### **SPECIFICATIONS**

### **ELECTRICAL CHARACTERISTICS**

4.5 V  $\leq$  V\_{S}  $\leq$  16 V, V\_{CM} = V\_S/2, T\_A = 25°C, unless otherwise noted.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	Vos			2	10	mV
Offset Voltage Drift	$\Delta V_{os}/\Delta T$	$-40^{\circ}C \le T_A \le +85^{\circ}C$		5		μV/°C
Input Bias Current	IB			80	600	nA
		$-40^{\circ}C \le T_{A} \le +85^{\circ}C$			800	nA
Input Offset Current	los			1	80	nA
		$-40^{\circ}C \le T_{A} \le +85^{\circ}C$			130	nA
Input Voltage Range		Common-mode input	-0.5		Vs + 0.5	v
Common-Mode Rejection Ratio	CMRR	$V_{CM} = 0 V$ to $V_{S}$ , $-40^{\circ}C \le T_A \le +85^{\circ}C$	54	95		dB
Large Signal Voltage Gain	Avo	$R_L = 10 \text{ k}\Omega$ , $V_O = 0.5 \text{ V}$ to $(V_S - 0.5 \text{ V})$	3	10		V/mV
Input Impedance	ZIN			400		kΩ
Input Capacitance	CIN			1		pF
OUTPUT CHARACTERISTICS						1
Output Voltage High	Voh	I <sub>L</sub> = 100 μA		Vs - 0.005		v
		$V_{s} = 16 V, I_{L} = 5 mA$	15.85	15.95		v
		-40°C ≤ T <sub>A</sub> ≤ +85°C	15.75			v
		$V_{s} = 4.5 V, I_{1} = 5 mA$	4.2	4.38		v
		-40°C ≤ T <sub>A</sub> ≤ +85°C	4.1			v
Output Voltage Low	Vol	$I_{L} = 100 \ \mu A$		5		mV
	02	$V_{s} = 16 V, I_{L} = 5 mA$		42	150	mV
		$-40^{\circ}C \le T_{A} \le +85^{\circ}C$			250	mV
		$V_{s} = 4.5 V, I_{L} = 5 mA$		95	300	mV
		-40°C ≤ T <sub>A</sub> ≤ +85°C			400	mV
Continuous Output Current	lout			35		mA
Peak Output Current	Ірк	$V_s = 16 V$		250		mA
POWER SUPPLY						
Supply Voltage	Vs		4.5		16	v
Power Supply Rejection Ratio	PSRR	$V_{s} = 4 V \text{ to } 17 V, -40^{\circ}C \le T_{A} \le +85^{\circ}C$	70	90		dB
Supply Current/Amplifier	I <sub>SY</sub>	$V_0 = V_s/2$ , no load	, 0	700	850	μA
	.51	$-40^{\circ}C \le T_{A} \le +85^{\circ}C$			1	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 10 \text{ k}\Omega, C_L = 200 \text{ pF}$	4	6		V/µs
Gain Bandwidth Product	GBP	$R_L = 10 \text{ k}\Omega, C_L = 200 \text{ pF}$		5		WHz
Phase Margin	Øm	$R_L = 10 \text{ k}\Omega_2$ , $C_L = 10 \text{ pF}$ $R_L = 10 \text{ k}\Omega_2$ , $C_L = 10 \text{ pF}$		65		Degree
Channel Separation	Øm			75		dB
NOISE PERFORMANCE		+		/5		ub
	en	f = 1 kHz		26		nV/√H
Voltage Noise Density	en en	f = 10  kHz		26 25		nV/√Hz
			1	11		$1 \Pi V / V \Pi A$

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 2.

Parameter	Rating
Supply Voltage (V <sub>s</sub> )	18 V
Input Voltage	-0.5 V to V <sub>s</sub> + 0.5 V
Differential Input Voltage	Vs
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	–65°C to +150°C
Lead Temperature (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for worst-case conditions, that is, for a device soldered onto a circuit board for surface-mount packages.

#### Table 3. Thermal Resistance

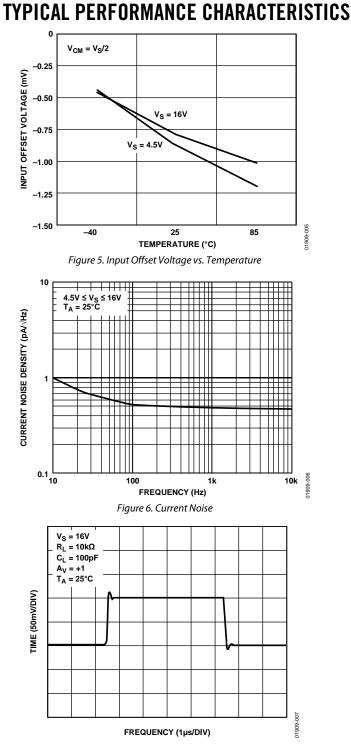
Package Type	θ <sub>JA</sub>	οıc	Unit
5-Lead SC70 (KS-5)	376	126	°C/W
8-Lead MSOP (RM-8)	210	45	°C/W
14-Lead TSSOP (RU-14)	180	35	°C/W
16-Lead LFCSP (CP-16-4)	38 <sup>1</sup>	30 <sup>1</sup>	°C/W

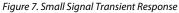
<sup>1</sup> DAP is soldered down to PCB.

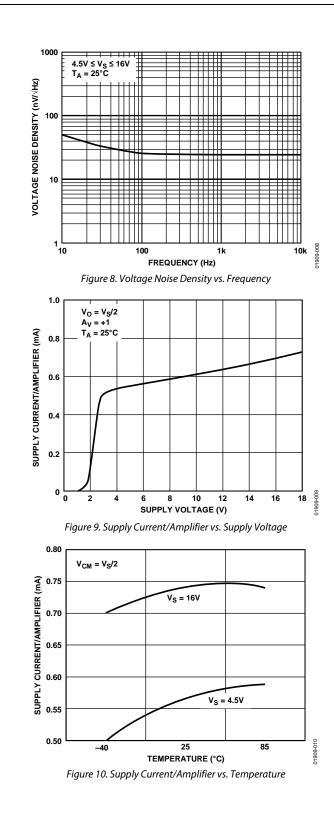
#### **ESD CAUTION**



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.







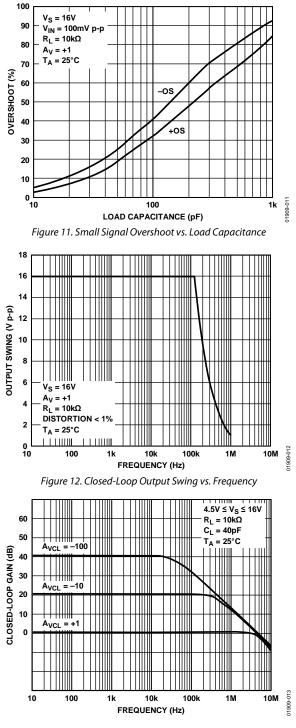


Figure 13. Closed-Loop Gain vs. Frequency

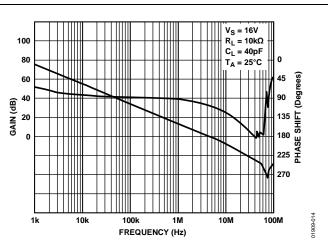


Figure 14. Open-Loop Gain and Phase Shift vs. Frequency

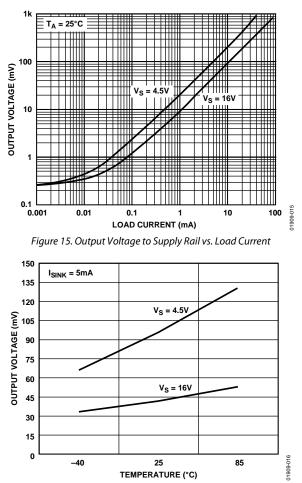


Figure 16. Output Voltage Swing to Rail vs. Temperature



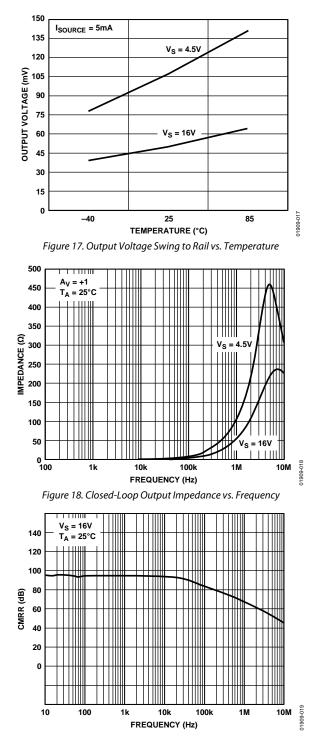
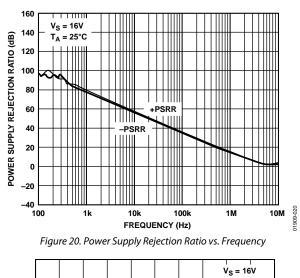


Figure 19. Common-Mode Rejection Ratio (CMRR) vs. Frequency



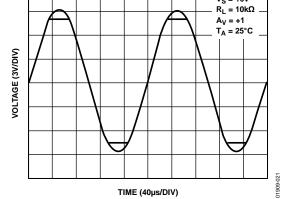


Figure 21. No Phase Reversal

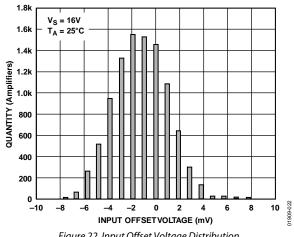
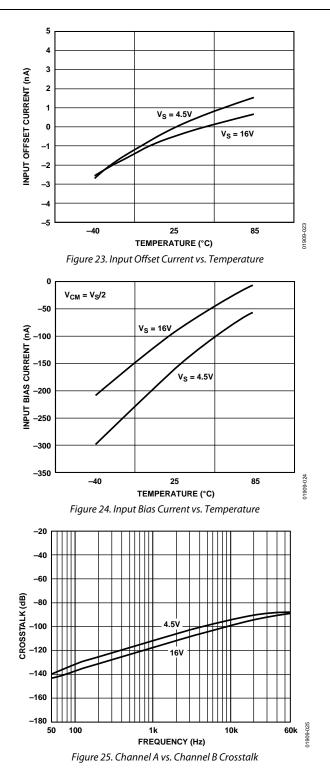
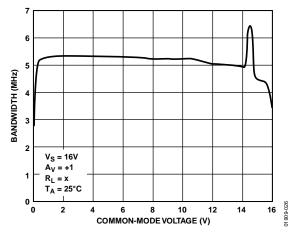
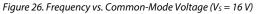


Figure 22. Input Offset Voltage Distribution







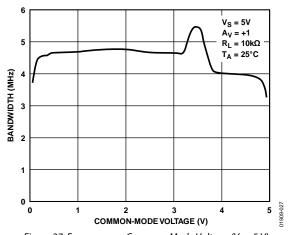


Figure 27. Frequency vs. Common-Mode Voltage ( $V_s = 5 V$ )

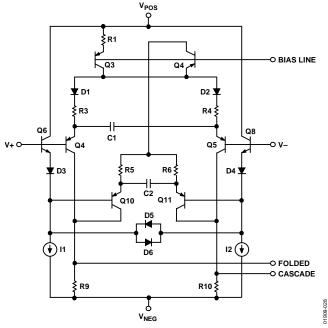
### **THEORY OF OPERATION**

The AD8565/AD8566/AD8567 are designed to drive large capacitive loads in LCD applications. They have high output current drive and rail-to-rail input/output operation and are powered from a single 16 V supply. They are also intended for other applications where low distortion and high output current drive are needed.

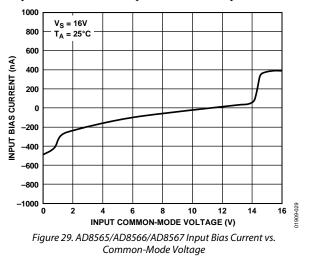
Figure 28 shows a simplified equivalent circuit for the AD8565/ AD8566/AD8567. The rail-to-rail bipolar input stage is composed of two PNP differential pairs, Q4 to Q5 and Q10 to Q11, operating in series with diode protection networks, D1 to D2. Diode network D1 to D2 serves as protection against large transients for Q4 to Q5 to accommodate rail-to-rail input swing. D5 to D6 protect Q10 to Q11 against Zenering. In normal operation, Q10 to Q11 are off, and their input stage is buffered from the operational amplifier inputs by Q6 to D3 and Q8 to D4.

Operation of the input stage is best understood as a function of applied common-mode voltage: when the inputs of the AD8565/ AD8566/AD8567 are biased midway between the supplies, the differential signal path gain is controlled by resistive loads Q4 to Q5 (via R9, R10). As the input common-mode level is reduced toward the negative supply ( $V_{NEG}$  or GND), the input transistor current sources, I1 and I2, are forced into saturation, thereby forcing the Q6 to D3 and Q8 to D4 networks into cutoff. However, Q4 to Q5 remain active, providing input stage gain.

Inversely, when common-mode input voltage is increased toward the positive supply, Q4 to Q5 are driven into cutoff, Q3 is driven into saturation, and Q4 becomes active, providing bias to the Q10 to Q11 differential pair. The point at which the Q10 to Q11 differential pair becomes active is approximately equal to  $(V_{POS} - 1 V)$ .



The benefit of this type of input stage is low bias current. The input bias current is the sum of base currents of Q4 to Q5 and Q6 to Q8 over the range from ( $V_{NEG} + 1 V$ ) to ( $V_{POS} - 1 V$ ). Outside this range, the input bias current is dominated by the sum of base currents of Q10 to Q11 for input signals close to  $V_{NEG}$  and of Q6 to Q8 (Q10 to Q11) for signals close to  $V_{POS}$ . From this type of design, the input bias current of the AD8565/AD8566/AD8567 not only exhibits different amplitude but also exhibits different polarities. Figure 29 provides the characteristics of the input bias current vs. the common-mode voltage. It is important to keep in mind that the source impedances driving the inputs are balanced for optimum dc and ac performance.



To achieve rail-to-rail output performance, the AD8565/ AD8566/AD8567 design uses a complementary commonsource (or gmRL) output. This con-figuration allows output voltages to approach the power supply rails, particularly if the output transistors are allowed to enter the triode region on extremes of signal swing, which are limited by  $V_{GS}$ , the transistor sizes, and output load current. In addition, this type of output stage exhibits voltage gain in an open-loop gain configuration. The amount of gain depends on the total load resistance at the output of the AD8565/AD8566/AD8567.

### INPUT OVERVOLTAGE PROTECTION

As with any semiconductor device, whenever the input exceeds either supply voltages, attention needs to be paid to the input overvoltage characteristics. As an overvoltage occurs, the amplifier could be damaged, depending on the voltage level and the magnitude of the fault current. When the input voltage exceeds either supply by more than 0.6 V, internal positive-negative (pn) junctions allow current to flow from the input to the supplies.

Figure 28. AD8565/AD8566/AD8567 Equivalent Input Circuit

This input current is not inherently damaging to the device as long as it is limited to 5 mA or less. If a condition exists using the AD8565/AD8566/AD8567 where the input exceeds the supply more than 0.6 V, an external series resistor should be added. The size of the resistor can be calculated by using the maximum over-voltage divided by 5 mA. This resistance should be placed in series with either input exposed to an overvoltage.

### **OUTPUT PHASE REVERSAL**

The AD8565/AD8566/AD8567 are immune to phase reversal. Although device output does not change phase, large currents due to input overvoltage could damage the device. In applications where the possibility of an input voltage exceeding the supply voltage exists, overvoltage protection should be used as described in the Input Overvoltage Protection section.

### **POWER DISSIPATION**

The maximum allowable internal junction temperature of 150°C limits the maximum power dissipation of AD8565/AD8566/AD8567 devices. As the ambient temperature increases, the maximum power dissipated by AD8565/AD8566/AD8567 devices must decrease linearly to maintain maximum junction temperature. If this maximum junction temperature is exceeded momentarily, the device still operates properly once the junction temperature is reduced below 150°C. If the maximum junction temperature is exceeded for an extended period, overheating could lead to permanent damage of the device.

The maximum safe junction temperature,  $T_{JMAX}$ , is 150°C. Using the following formula, the maximum power that an AD8565/AD8566/AD8567 device can safely dissipate as a function of temperature can be obtained:

$$P_{DISS} = T_{JMAX} - T_A/\theta_{JA}$$

where:

 $P_{DISS}$  is the AD8565/AD8566/AD8567 power dissipation.  $T_{JMAX}$  is the AD8565/AD8566/AD8567 maximum allowable junction temperature (150°C).

 $T_A$  is the ambient temperature of the circuit.

 $\theta_{\text{JA}}$  is the AD8565/AD8566/AD8567 package thermal resistance, junction-to-ambient.

The power dissipated by the device can be calculated as

 $P_{DISS} = (V_S - V_{OUT}) \times I_{LOAD}$ 

where:

 $V_S$  is the supply voltage.  $V_{OUT}$  is the output voltage.  $I_{LOAD}$  is the output load current.

Figure 30 shows the maximum power dissipation vs. temperature. To achieve proper operation, use the previous equation to calculate  $P_{DISS}$  for a specific package at any given temperature or use Figure 30.

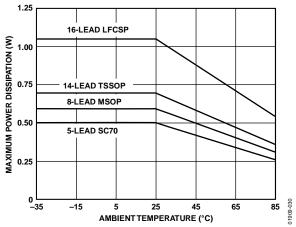


Figure 30. Maximum Power Dissipation vs. Temperature for 5-Lead SC70, 8-Lead MSOP, 14-Lead TSSOP, and 16-Lead LFCSP Packages

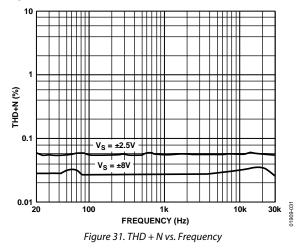
#### THERMAL PAD—AD8567

The AD8567 LFCSP comes with a thermal pad that is attached to the substrate. This substrate is connected to  $V_{DD}$ . To be electrically safe, the thermal pad should be soldered to an area on the board that is electrically isolated or connected to  $V_{DD}$ . Attaching the thermal pad to ground adversely affects the performance of the part.

Soldering down this thermal pad dramatically improves the heat dissipation of the package. It is necessary to attach vias that connect the soldered thermal pad to another layer on the board. This provides an avenue to dissipate the heat away from the part. Without vias, the heat is isolated directly under the part.

### TOTAL HARMONIC DISTORTION + NOISE (THD + N)

The AD8565/AD8566/AD8567 feature low total harmonic distortion. Figure 31 shows THD + N vs. frequency. The THD + N over the entire supply range is below 0.008%. When the device is powered from a 16 V supply, the THD + N stays below 0.003%. Figure 31 shows the AD8566 in a unity noninverting configuration.



#### SHORT-CIRCUIT OUTPUT CONDITIONS

The AD8565/AD8566/AD8567 do not have internal shortcircuit protection circuitry. As a precautionary measure, it is recommended not to short the output directly to the positive power supply or to ground.

It is not recommended to operate the AD8565/AD8566/AD8567 with more than 35 mA of continuous output current. The output current can be limited by placing a series resistor at the output of the amplifier whose value can be derived using

$$R_X \ge \frac{V_S}{35 \text{ mA}}$$

For a 5 V single-supply operation,  $R_{\rm X}$  should have a minimum value of 143  $\Omega.$ 

### LCD PANEL APPLICATIONS

The AD8565/AD8566/AD8567 amplifier is designed for LCD panel applications or applications where large capacitive load drive is required. It can instantaneously source/sink greater than 250 mA of current. At unity gain, it can drive 1  $\mu$ F without compensation. This makes the AD8565/AD8566/AD8567 ideal for LCD V<sub>COM</sub> driver applications.

To evaluate the performance of the AD8565/AD8566/AD8567, a test circuit was developed to simulate the  $V_{COM}$  driver application for an LCD panel. Figure 32 shows the test circuit. Series capacitors and resistors connected to the output of the op amp represent the load of the LCD panel. The 300  $\Omega$  and 3 k $\Omega$  feedback resistors are used to improve settling time. This test circuit simulates the worst-case scenario for a  $V_{COM}$ . It drives a represented load that is connected to a signal switched symmetrically around  $V_{COM}$ .

Figure 33 shows a scope photo of the instantaneous output peak current capability of the AD8565/AD8566/AD8567.

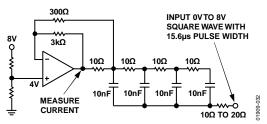


Figure 32. V<sub>COM</sub> Test Circuit with Supply Voltage at 16 V

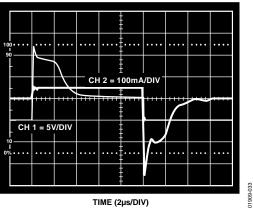
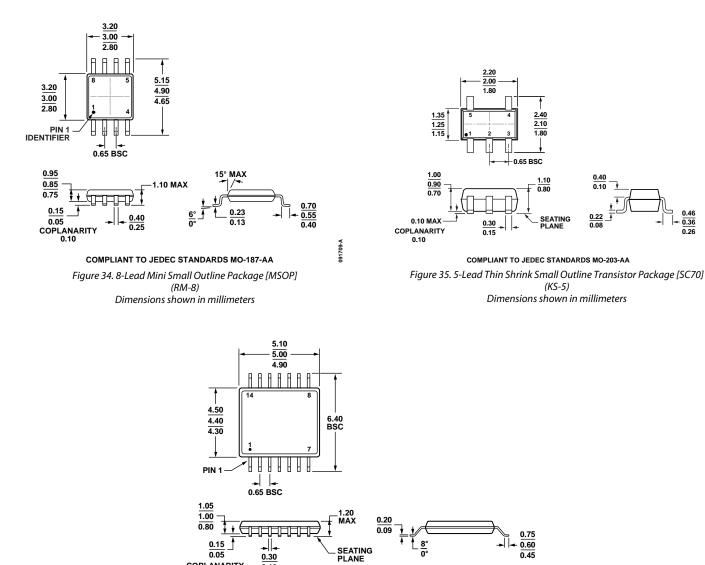


Figure 33. Scope Photo of the V<sub>COM</sub> Instantaneous Peak Current

### **OUTLINE DIMENSIONS**



0.46 0.36 0.26

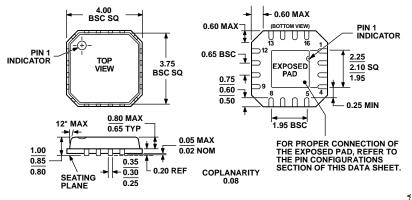
072809-A

COMPLIANT TO JEDEC STANDARDS MO-153-AB-1 Figure 36. 14-Lead Thin Shrink Small Outline Package [TSSOP] (RU-14) Dimensions shown in millimeters

061908-A

COPLANARITY 0.10

0.19



COMPLIANT TO JEDEC STANDARDS MO-220-VGGC

072808-A

Figure 37. 16-Lead Lead Frame Chip Scale Package [LFCSP\_VQ] 4 mm × 4 mm Body, Very Thin Quad (CP-16-4) Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model <sup>1</sup>	Abs Max (V)	Temperature Range	Package Description	Package Option	Branding
AD8565AKS-R2	18	-40°C to +85°C	5-Lead Thin Shrink Small Outline Transistor Package (SC70)	KS-5	ASA
AD8565AKSZ-REEL7	18	-40°C to +85°C	5-Lead Thin Shrink Small Outline Transistor Package (SC70)	KS-5	AON
AD8566ARM-R2	18	-40°C to +85°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	ATA
AD8566ARM-REEL	18	-40°C to +85°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	ATA
AD8566ARMZ-R2	18	-40°C to +85°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	ATA#
AD8566ARMZ-REEL	18	-40°C to +85°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	ATA#
AD8566WARMZ-REEL	18	-40°C to +85°C	8-Lead Mini Small Outline Package (MSOP)	RM-8	LG3
AD8567ARU	18	-40°C to +85°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14	
AD8567ARU-REEL	18	-40°C to +85°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14	
AD8567ARUZ	18	-40°C to +85°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14	
AD8567ARUZ-REEL	18	-40°C to +85°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14	
AD8567ACP-R2	18	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-16-4	
AD8567ACP-REEL7	18	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-16-4	
AD8567ACPZ-R2	18	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-16-4	
AD8567ACPZ-REEL	18	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-16-4	
AD8567ACPZ-REEL7	18	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-16-4	

<sup>1</sup> Z = RoHS Compliant Part.

# NOTES

# NOTES

### NOTES



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Rev. F | Page 16 of 16